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01-27-2009			

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SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT	
NATURE OF CONVEYANCE:	Corrective Assignment to correct the Assignee previously recorded on Reel 021930 Frame 0788. Assignor(s) hereby confirms the Assignee should be Semiconductor Components Industries, LLC.	

CONVEYING PARTY DATA

	lame	Execution Date
Pavel Horsky		10/30/2008
Petr Kamenicky		10/30/2008

RECEIVING PARTY DATA

Name:	Semiconductor Components Industries, LLC
Street Address:	5005 East McDowell Road
City:	Phoenix
State/Country:	ARIZONA
Postal Code:	85008

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12190535

CORRESPONDENCE DATA

Fax Number:

(801)328-1707

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone:

RECURD AS OF 12/18/69

801-533-9800

Email:

grendon@wnlaw.com

Correspondent Name:

Adrian J. Lee

Address Line 1:

1000 Eagle Gate Tower

Address Line 2:

60 East South Temple

Address Line 4:

Salt Lake City, UTAH 84111

ATTORNEY DOCKET NUMBER:

14993.75

NAME OF SUBMITTER:

Adrian J. Lee

Total Attachments: 4

PATENT REEL: 022179 FRAME: 0664

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1 12/05/2008 500722473

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Pavel Horsky	10/30/2008
Pert Kamenicky	10/30/2008

RECEIVING PARTY DATA

Name:	Microsoft Corporation
Street Address:	One Microsoft Way
City:	Redmond
State/Country:	WASHINGTON
Postal Code:	98052

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12190535

CORRESPONDENCE DATA

Fax Number: (801)328-1707

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 801-533-9800

Email: grendon@wnlaw.com

Correspondent Name: Adrian J. Lee

Address Line 1: 1000 Eagle Gate Tower

Address Line 2: 60 East South Temple

Address Line 4: Salt Lake City, UTAH 84111

ATTORNEY DOCKET NUMBER: 14993.75

NAME OF SUBMITTER: Adrian J. Lee

Total Attachments: 4

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> PATENT REEL: 022179 FRAME: 0665

JP \$40.00 12190535

ASSIGNMENT & AGREEMENT

Docket Number: 14993.75

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

Pavel Horsky of Seifertova 8, Brno 63800, Czech Republic

Petr Kamenický of Na Padelkach 7, Brno 64100, Czech Republic

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in:

Application Title: EMC PROTECTION CIRCUIT

Attorney Docket No. 14993.75

described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof. We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI; but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all

PATENT REEL: 022179 FRAME: 0666

ASSIGNMENT & AGREEMENT Docket Number: 14993.75

countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

ASSIGNMENT & AGREEMENT

Docket Number: 14993.75

Pavel Horsky

30. 10. 200P

Date

ASSIGNMENT & AGREEMENT Docket Number: 14993.75

Petr Kamenicky

50,10, 2008

Date -

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PATENT REEL: 022179 FRAME: 0669

RECORDED: 01/22/2009